

Contents

Processor Architecture

Modeling and Analyzing of 3D DRAM as L3 Cache Based on DRAMSim2.	3
<i>Litiao Qiu, Lei Wang, Qiang Dou, and Zhenyu Zhao</i>	
Partitioning Methods for Multicast in Bufferless 3D Network on Chip.	13
<i>Chaoyun Yao, Chaochao Feng, Minxuan Zhang, Wei Guo, Shouzhong Zhu, and Shaojun Wei</i>	
Thermal-Aware Floorplanner for Multi-core 3D ICs with Interlayer Cooling	23
<i>Wei Guo, Minxuan Zhang, Peng Li, Chaoyun Yao, and Hongwei Zhou</i>	
The Improvement of March C+ Algorithm for Embedded Memory Test	31
<i>Yongwen Wang, Qianbing Zheng, and Yin Yuan</i>	
Mitigating Soft Error Rate Through Selective Replication in Hybrid Architecture.	38
<i>Chao Song and Minxuan Zhang</i>	

Application Specific Processors

A New Memory Address Transformation for Continuous-Flow FFT Processors with SIMD Extension	51
<i>Chao Yang, Haiyan Chen, Sheng Liu, and Sheng Ma</i>	
Designing Parallel Sparse Matrix Transposition Algorithm Using ELLPACK-R for GPUs	61
<i>Song Guo, Yong Dou, Yuanwu Lei, Qiang Wang, Fei Xia, and Jianning Chen</i>	
Channel Estimation in Massive MIMO: Algorithm and Hardware	69
<i>Chuan Tang, Cang Liu, Luechao Yuan, and Zuocheng Xing</i>	
A ML-Based High-Accuracy Estimation of Sampling and Carrier Frequency Offsets for OFDM Systems	85
<i>Cang Liu, Luechao Yuan, Zuocheng Xing, Xiantuo Tang, and Guitao Fu</i>	
A High-PSRR CMOS Bandgap Reference Circuit.	94
<i>Chang Liping, An Kang, Liu Yao, Liang Bin, and Li Jinwen</i>	

Computer Application and Software Optimization

Detection and Analysis of Water Army Groups on Virtual Community	105
<i>Guirong Chen, Wandong Cai, Jiuming Huang, Huijie Xu, Rong Wang, Hua Jiang, and Fengqin Zhang</i>	
Accelerating Molecular Dynamics Simulations on Heterogeneous Architecture	118
<i>Yueqing Wang, Yong Dou, Song Guo, Yuanwu Lei, Baofeng Li, and Qiang Wang</i>	
A Cloud Server Based on I/O Virtualization in Hardware.	133
<i>Yang You, Gongbo Li, Xiaojun Yang, Bowen Qi, and Bingzhang Wang</i>	
The Evolution of Supercomputer Architecture: A Historical Perspective.	145
<i>Bao Li and Pingjing Lu</i>	

Technology on the Horizon

Simulation of Six DOF Vibration Isolator System for Electronic Equipment . . .	157
<i>Yufeng Luo, Jinwen Li, Yuanshan Li, and Xu Chen</i>	
Impact of Heavy Ion Species and Energy on SEE Characteristics of Three-Dimensional Integrated Circuit.	164
<i>Peng Li, Wei Guo, Zhenyu Zhao, and Minxuan Zhang</i>	
Analysis and Simulation of Temperature Characteristic of Sensitivity for SOI Lateral PIN Photodiode Gated by Transparent Electrode.	173
<i>Bin Wang, Yun Zeng, Guoli Li, Yu Xia, Hui Xu, and Caixia Huang</i>	
Mitigation Techniques Against TSV-to-TSV Coupling in 3DIC	182
<i>Quan Deng, Minxuan Zhang, Zhenyu Zhao, and Peng Li</i>	
Author Index	191

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